Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the

application:

Listing of Claims:

1. (Currently Amended) An image sensor comprising:

a plurality of pixels formed in a semiconductor substrate, each pixel including a light

sensitive element;

a micro-lens over each of said light sensitive elements; and

a raised ridge structure surrounding each of said micro-lenses, wherein said raised ridge

structure has a triangular cross-section and at least partially supports said micro-lens, wherein the

micro-lens overlays a base portion of the raised ridge structure.

2. (Original) The image sensor of Claim 1 wherein said raised ridge structure is

circular.

3. (Previously Presented) The image sensor of Claim 1 wherein said raised ridge

structure confines said micro-lens.

4. (Original) The image sensor of Claim 1 wherein the micro-lenses are formed from

-2-

polymethylmethacrylate (PMMA) or polyglycidylmethacrylate (PGMA).

Serial No.: 10/603,729

Filing Date: June 24, 2003

Examiner: Gregory V. Madden

Art Unit: 2622

5. (Currently Amended) The image sensor of Claim 1 wherein said raised ridge

structure has a height of about 0.2 microns.

6. (Original) The image sensor of Claim 1 wherein said raised ridge structure is

formed from the same material that underlies said micro-lenses.

7. (Original) The image sensor of Claim 1 further including a color filter layer

between said micro-lenses and said light sensitive elements.

8. (Currently Amended) A pixel of an image sensor comprising:

a light sensitive element formed in a semiconductor substrate;

a micro-lens over said light sensitive element; and

a raised ridge structure surrounding said micro-lens, wherein said raised ridge structure

has a triangular cross-section and at least partially supports said micro-lens, wherein the micro-

lens overlays a base portion of the raised ridge structure.

9. (Original) The pixel of Claim 8 wherein said raised ridge structure is circular.

10. (Previously Presented) The pixel of Claim 8 wherein said raised ridge structure

confines said micro-lens.

11. (Original) The pixel of Claim 8 wherein the micro-lens is formed from

-3-

polymethylmethacrylate (PMMA) of polyglycidylmethacrylate (PGMA).

Serial No.: 10/603,729

Filing Date: June 24, 2003

Examiner: Gregory V. Madden

Art Unit: 2622

12. (Currently Amended) The pixel of Claim 8 wherein said raised ridge structure has

a height of about 0.2 microns.

13. (Original) The pixel of Claim 8 wherein said raised ridge structure is formed from

the same material that underlies said micro-lenses.

14. (Original) The pixel of Claim 8 further including a color filter layer between said

micro-lens and said light sensitive element.

15. (Currently Amended) A method of forming a pixel of an image sensor

comprising:

forming a light sensitive element in a semiconductor substrate;

forming a top planarizing layer over said light sensitive element;

isotropically etching the top planarizing layer to form forming a raised structure over said

top planarizing layer, said raised ridge structure encompassing said light sensitive element; and

forming a microlens within the interior of said raised ridge structure and over said light

sensitive element, wherein said raised ridge structure has a triangular cross-section and at least

partially supports said micro-lens, wherein the micro-lens overlays a base portion of the raised

ridge structure.

16. (Original) The method of Claim 15 wherein said raised ridge structure is formed

in said top planarizing layer.

-4- Examiner: Gregory V. Madden

Art Unit: 2622

- (Previously Presented) The method Claim 15 wherein said raised ridge structure 17. confines said micro-lens.
- (Original) The method of Claim 15 wherein said raised ridge structure is a closed 18. shape.
- (Original) The method of Claim 15 further including forming a color filter layer 19. between said micro-lens and said light sensitive element.

Serial No.: 10/603,729 -5-Art Unit: 2622 Filing Date: June 24, 2003